IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



the Application of

DONALD C. ABBOTT ET AL.

Serial No. 10/724,498 (TI-28098.1)

Filed: December 1, 2003

For: SEMICONDUCTOR CIRCUIT ASSEMBLY HAVING PLATED LEADFRAME INCLUDING GOLD SELECTIVELY COVERING AREAS TO BE SOLDERED

Art Unit 2814

Examiner Wael M. Fahmy

Customer No. 23494

Director of the United States Patent and Trademark Office P. O. Box 1450 Alexandria, VA 22313-1450 CERTIFICATE OF MAILING OR TRANSMISSION UNDER 37 CFR 1.8

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Jav M. Cantor, Reg. No. 19,906

AMENDMENT UNDER 37 C.F.R. 1.116

Dear Sir:

In response to the Office action dated March 22, 2006, the following remarks are presented: